

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

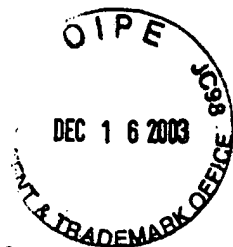
In re Application of

Yoshihisa KATO, et al.

Serial No.: 10/653,201

Filed: September 03, 2003

For: SEMICONDUCTOR DEVICE, METHOD FOR FABRICATING THE SAME, AND  
METHOD FOR DRIVING THE SAME



: Customer Number: 20277

: Confirmation Number: 1757

: Group Art Unit: 2818

: Examiner: Unknown

**REQUEST FOR CORRECTED FILING RECEIPT**

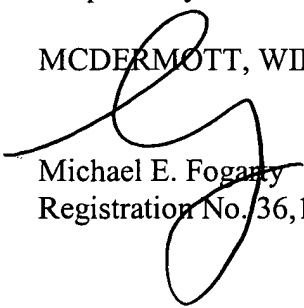
Mail Stop OFR  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Attached is a copy of the Filing Receipt received from the U.S. Patent and Trademark Office in the above-referenced application. It is noted that the Foreign Application date is incorrect. Attached is a copy of the Declaration and Power of Attorney, which evidences that the correct date should read: 09/04/2002. It is requested that a corrected filing receipt be issued.

Respectfully submitted,

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**Date: December 16, 2003**



## UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE  
 United States Patent and Trademark Office  
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APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/653,201	09/03/2003	2818	918	60188-639	22	17	5

Jack Q. Lever, Jr.  
 McDERMOTT, WILL & EMERY  
 600 Thirteenth Street, N.W.  
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CONFIRMATION NO. 1757

## FILING RECEIPT



\*OC000000011335688\*

Date Mailed: 11/24/2003

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

## Applicant(s)

Yoshihisa Kato, Shiga, JAPAN;  
 Yasuhiro Shimada, Kyoto, JAPAN;  
 Takayoshi Yamada, Osaka, JAPAN;

## Assignment For Published Patent Application

MATSUSHITA ELECTRIC INDUSTRIAL CO., LTD.;

## Domestic Priority data as claimed by applicant

## Foreign Applications

JAPAN 2002-258816 04/09/2002

If Required, Foreign Filing License Granted: 11/21/2003

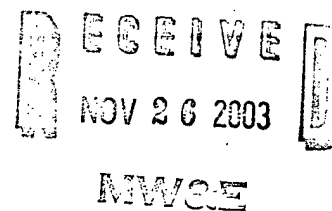
Projected Publication Date: 03/04/2004

Non-Publication Request: No

Early Publication Request: No

## Title

Semiconductor device, method for fabricating the same, and method for driving the same



**Preliminary Class**

365

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Title 35, United States Code, Section 184  
Title 37, Code of Federal Regulations, 5.11 & 5.15**

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**COMBINED DECLARATION/POWER OF ATTORNEY**  
**FOR PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

**SEMICONDUCTOR DEVICE, METHOD FOR FABRICATING THE SAME, AND METHOD FOR DRIVING THE SAME**, the specification of which

(check one)        X   is attached hereto.

\_\_\_\_\_ was filed on \_\_\_\_\_ as  
Application Serial No. \_\_\_\_\_.

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)			Priority Claimed
<u>2002-258816</u>	<u>JAPAN</u>	<u>04/09/2002</u>	<u>  X  </u> Yes <u>    </u> No
(Number)	(Country)	(Day/Month/Year Filed)	
_____	_____	_____	<u>    </u> Yes <u>    </u> No
(Number)	(Country)	(Day/Month/Year Filed)	
_____	_____	_____	<u>    </u> Yes <u>    </u> No
(Number)	(Country)	(Day/Month/Year Filed)	

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

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(Appln. Serial No.)

(Filing Date)

(Status-patented, pending, abandoned)

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(Appln. Serial No.)

(Filing Date)

(Status-patented, pending, abandoned)

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I hereby appoint as my attorneys, with full power of substitution and revocation, to prosecute the patent application identified above and to transact all business in the U.S. Patent and Trademark Office connected therewith: Raphael V. Lupo (Reg. No. 28,363); Jack Q. Lever, Jr. (Reg. No. 28,149); Kenneth L. Cage (Reg. No. 26,151); Stanislaus Aksman (Reg. No. 28,562); Paul Devinsky (Reg. No. 28,553); Edward E. Kubasiewicz (Reg. No. 30,020), Michael E. Fogarty (Reg. No. 36,139); Brian E. Ferguson (Reg. No. 36,801); Robert W. Zelnick (Reg. No. 36,976); and Wilhlem F. Gadiano (Reg. No. 37,136).

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The undersigned hereby authorizes the U.S. attorneys named herein to accept and follow instructions from Maeda Patent Office as to any action to be taken in the Patent and Trademark Office regarding this application without direct communication between the U.S. attorney and the undersigned. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by the undersigned.

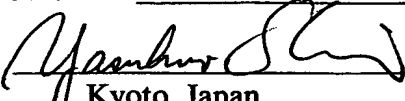
I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

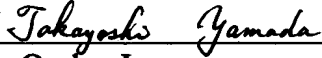
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